AMENDMENTS TO THE CLAIMS

A listing of all claims and their current status in accordance with 37 C.F.R. § 1.121(c) is provided below.

- (currently amended) A method of configuring a system comprising:
 reading operating current values from a non-volatile memory device on a memory
 module, wherein the memory module comprises a plurality of volatile
 memory devices, and wherein the operating current parameters values
 comprise operating currents uniquely corresponding to a lot in which the
 volatile memory devices were manufactured; and
 configuring the system in accordance with the operating current values from the
 non-volatile memory device on the memory module.
- 2. (original) The method, as set forth in claim 1, wherein reading comprises reading operating current values from a serial presence detect device.
- 3. (original) The method, as set forth in claim 1, wherein reading comprises reading operating current values from a non-volatile memory device on a dual inline memory module.

Serial No. 10/816,239 Amendment and Response to Office Action Mailed June 26, 2006

- 4. (original) The method, as set forth in claim 1, wherein reading comprises reading the operating current values from the non-volatile memory device during a boot of the system.
- 5. (original) The method, as set forth in claim 1, wherein configuring comprises setting operating current thresholds in the system in accordance with the operating current values.
- 6. (original) The method, as set forth in claim 5, comprising throttling the memory module if an actual operating current in the memory module exceeds one of the operating current thresholds.
- 7. (original) A method of configuring a system comprising:
 reading operating current values from a non-volatile memory device on a memory module, wherein the memory module comprises a plurality of volatile memory devices, and wherein the operating current values comprise operating currents uniquely corresponding to each of the plurality of memory devices; and
 - configuring the system in accordance with the operating current values from the non-volatile memory device on the memory module.

Serial No. 10/816,239 Amendment and Response to Office Action Mailed June 26, 2006

- 8. (original) The method, as set forth in claim 7, wherein reading comprises reading operating current values from a serial presence detect device.
- 9. (original) The method, as set forth in claim 7, wherein reading comprises reading operating current values from a non-volatile memory device on a dual inline memory module.
- 10. (original) The method, as set forth in claim 7, wherein reading comprises reading the operating current values from the non-volatile memory device during a boot of the system.
- 11. (original) The method, as set forth in claim 7, wherein configuring comprises setting operating current thresholds in the system in accordance with the operating current values.
- 12. (original) The method, as set forth in claim 11, comprising throttling the memory module if an actual operating current in the memory module exceeds one of the operating current thresholds.
- (original) A method of manufacturing a memory module comprising:
 measuring operating current values in each of a plurality of volatile memory devices;

storing each of the operating current values corresponding to each of the plurality of volatile memory devices in a non-volatile memory device; and forming a memory module comprising each of the plurality of volatile memory devices and the non-volatile memory device.

- 14. (original) The method, as set forth in claim 13, wherein measuring comprises measuring the operating current values in each of a plurality of dynamic random access memory devices.
- 15. (original) The method, as set forth in claim 13, wherein storing comprises storing each of the operating current values corresponding to each of the plurality of volatile memory devices in a serial presence detect device.
- 16. (original) The method as set forth in claim 13, wherein forming comprises forming a dual inline memory module.
- 17. (original) A method of manufacturing a memory module comprising:

 measuring operating current values in each of a plurality of volatile memory

 devices, wherein the plurality of volatile memory devices correspond to a

 single manufacturing lot;

calculating average operating current values for the manufacturing lot; storing the average operating current values in a non-volatile memory device; and forming a memory module comprising each of the plurality of volatile memory devices and the non-volatile memory device.

- 18. (original) The method, as set forth in claim 17, wherein measuring comprises measuring the operating current values in each of a plurality of dynamic random access memory devices.
- 19. (original) The method, as set forth in claim 17, wherein storing comprises storing the average operating current values in a serial presence detect device.
- 20. (original) The method as set forth in claim 17, wherein forming comprises forming a dual inline memory module.
- 21. (original) A memory module comprising:
 a plurality of volatile memory devices; and
 a non-volatile memory device having operating current values uniquely
 corresponding to a lot in which the plurality of volatile memory devices
 were manufactured stored thereon.
- 22. (original) The memory module, as set forth in claim 21, wherein the memory module comprises a dual inline memory module.

- 23. (original) The memory module, as set forth in claim 21, wherein each of the plurality of volatile memory devices comprises a dynamic random access memory device.
- 24. (original) The memory module, as set forth in claim 21, wherein the non-volatile memory device comprises a serial presence detect device.
- 25. (original) A memory module comprising:
 a plurality of volatile memory devices; and
 a non-volatile memory device having operating current values uniquely
 corresponding to each of the plurality of volatile memory devices stored
 thereon.
- 26. (original) The memory module, as set forth in claim 25, wherein the memory module comprises a dual inline memory module.
- 27. (original) The memory module, as set forth in claim 25, wherein each of the plurality of volatile memory devices comprises a dynamic random access memory device.
- 28. (original) The memory module, as set forth in claim 25, wherein the non-volatile memory device comprises a serial presence detect device.

29. (original) A computer system comprising:

a processor; and

a memory module coupled to the processor and comprising:

a plurality of volatile memory devices; and

a non-volatile memory device having operating current values uniquely corresponding to each of the plurality of volatile memory devices stored thereon.

- 30. (original) The computer system, as set forth in claim 29, wherein the memory module comprises a dual inline memory module.
- 31. (original) The computer system, as set forth in claim 29, wherein each of the plurality of volatile memory devices comprises a dynamic random access memory device.
- 32. (original) The computer system, as set forth in claim 29, wherein the non-volatile memory device comprises a serial presence detect device.